

Li Feng (Felicia)

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EDUCATION

Hong Kong University of Science and Technology (Guangzhou) Ph.D. in Computational Media and Arts, Advisor: Dr. Mingming Fan, Co-advisor: Dr. Huamin Qu	Guangzhou, China 2022–Current
City University of Hong Kong B.S. in Computer Science, First Class Honor	Hong Kong SAR 2018–2022

PROFESSIONAL EXPERIENCE

City University of Hong Kong Research Assistant at ERFI Lab	Hong Kong SAR 2021–2022
City University of Hong Kong Technical Assistant at the Department of Public Policy	Hong Kong SAR 2021–2022
Reasonable Software House Ltd. Software Engineering Trainee	Hong Kong SAR 2020–2021

PUBLICATIONS

- Zisu Li, **Li Feng**, Chen Liang, Yuru Huang and Mingming Fan. “Exploring The Opportunities of AR for Enriching Storytelling With Family Photos Among Grandparents and Grandchildren” Proceedings of ACM on Interactive, Mobile, Wearable and Ubiquitous Technologies (IMWUT) (Accepted, In press).
- **Li Feng**, Zeyu Xiong, Xinyi Li and Mingming Fan. “CoPracTter: Toward Integrating Personalized Practice Scenarios, Timely Feedback and Social Support into An Online Support Tool for Coping with Stuttering in China.” In Proceedings of the ACM Conference on Human Factors in Computing Systems (CHI), 2023.
- Hen Chen Yen, **Li Feng**, Brinda Mehra, Ching Christie PANG, Siying Hu and Zhicong Lu. “StoryChat: Designing a Narrative-Based Viewer Participation Tool for Live Streaming Chatrooms.” In Proceedings of the ACM Conference on Human Factors in Computing Systems (CHI), 2023.
- Can Liu, Siying Hu, **Li Feng** and Mingming Fan. “Typist Experiment: an Investigation of Human-to-Human Dictation via Role-play to Inform Voice-based Text Authoring.” Proceedings of the ACM on Human-Computer Interaction (PACM HCI), 6, CSCW2, Article 199 (Nov. 2022)

SCHOLARSHIPS AND AWARDS

• City University of Hong Kong Mainland Student Full Tuition Scholarship,	2018–2022
• City University of Hong Kong College of Engineering Dean’s List,	2018–2022
• Huawei Innovation Competition Second Prize,	2022
• Huawei MindSpore Challenge Pitching Score Winner and Model Score Runner-up,	2021